

## Features

- Frequency Range DC-14GHz
- 51.5dBm Nominal  $P_{3dB}$  Pulsed
- Maximum PAE at 6GHz of 71%
- 18dB Linear Gain at 6GHz
- Drain Bias 28V
- Technology: GaN on SiC
- Lead-free and RoHS compliant
- Chip Dimensions: 0.82 x 4.56 x 0.10mm

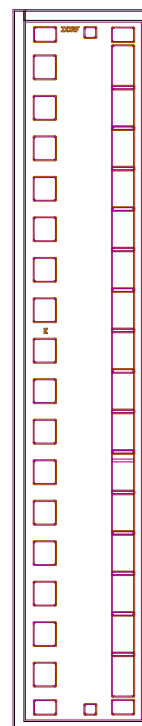
## Applications

- Aerospace & Defense
- Broadband Wireless

## Description

The ICPB1020 is a GaN on SiC discrete HEMT that operates from DC-14GHz. The design is optimized for power and efficiency using field plate technology.

## Image



## RF Performance | Simulated Conditions unless otherwise stated | $T_A=25^\circ\text{C}$ , $V_D=28\text{V}$ , Pulse Width 100uS, Duty Cycle=10%

Parameter	Units	Typical			
		3	6	10	14
Frequency	GHz	3	6	10	14
Output Power $P_{3dB}$	dB	51.6	51.6	51.6	51.6
Bias Current	mA	400	400	400	400
PAE @ $P_{3dB}$	%	77.7	71.4	64.4	55.7
Gain @ $P_{3dB}$	dB	21	15	10.1	7.4

## Recommended operating conditions

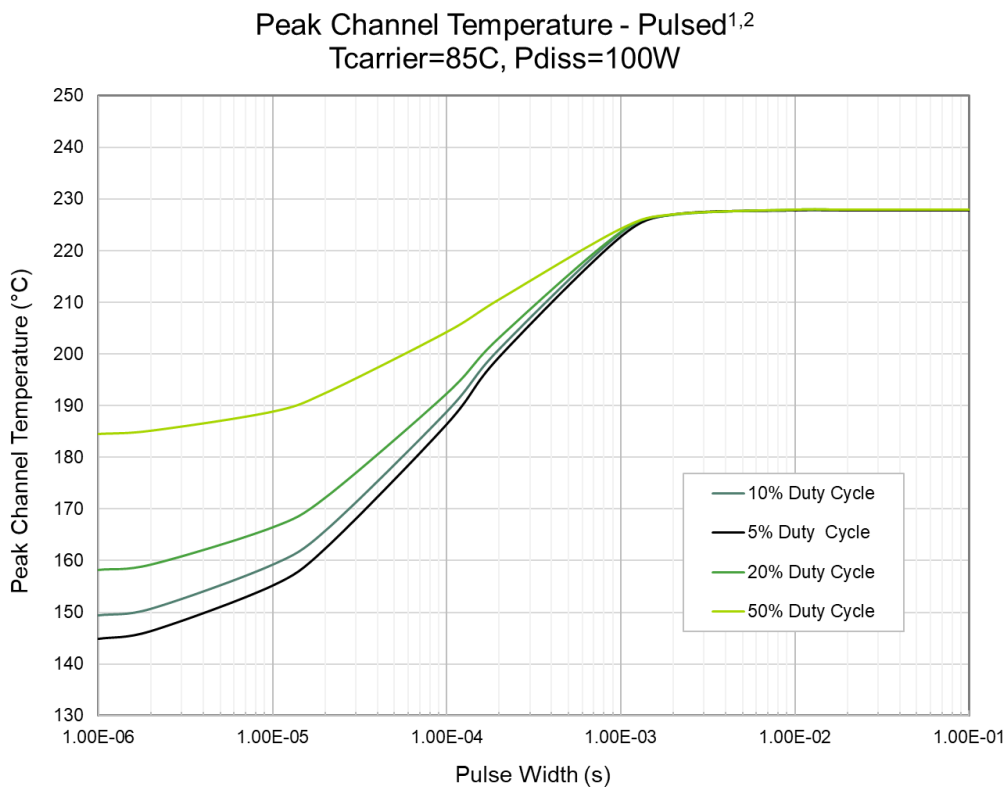
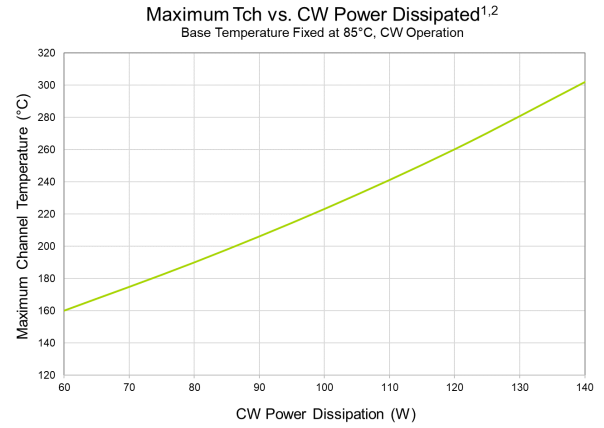
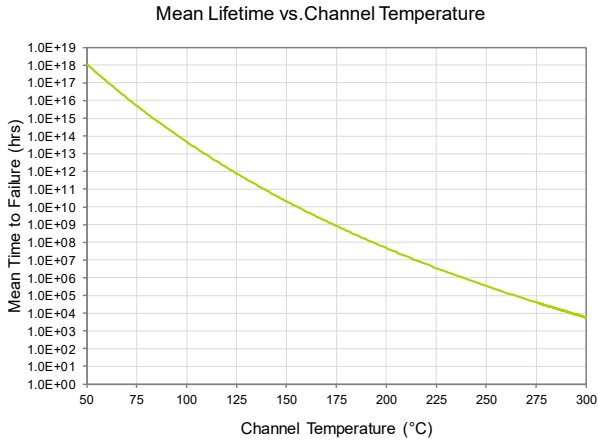
Parameter	Value
Drain Voltage ( $V_{DG}$ )	12-32 V
Drain Quiescent Current ( $I_D$ )	0.4-1A
Drain current RF Drive ( $I_D$ )	8A
Gate Voltage ( $V_G$ )	-3V
Power Dissipation (CW)	112W
Channel Temperature (Max)	225°C

## Absolute Maximum Ratings

Parameter	Absolute Maximum
Drain to Gate Voltage ( $V_{DG}$ )	80 V
Gate Voltage Range ( $V_G$ )	-20V to 0V
Gate Current ( $I_G$ )	-20 to 60mA
Power Dissipation (CW)	128W
CW Input Power	+43dBm
Channel Temperature	275°C
Storage Temperature	-65°C to +150°C

Exceeding any one or combination of these limits may cause permanent damage to this device. ICONIC RF does not recommend sustained operation near these survivability limits.

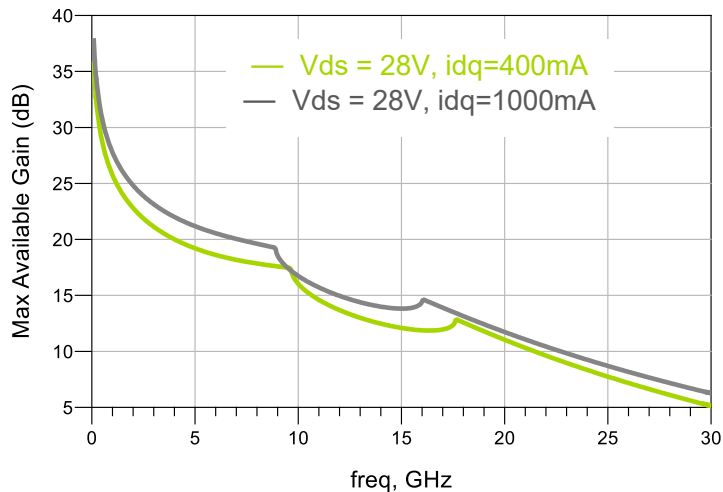
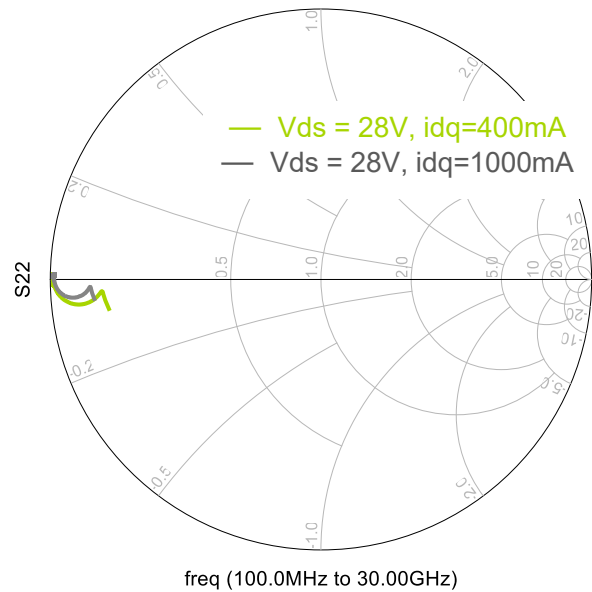
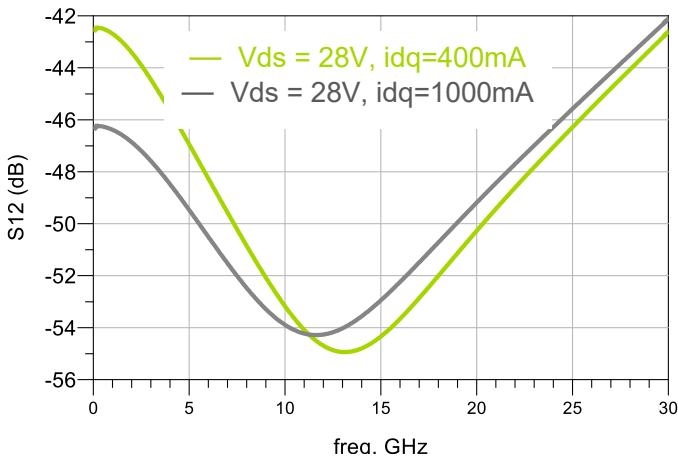
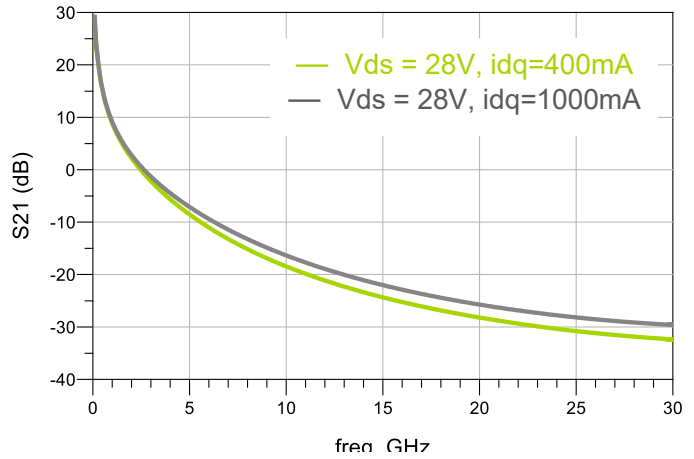
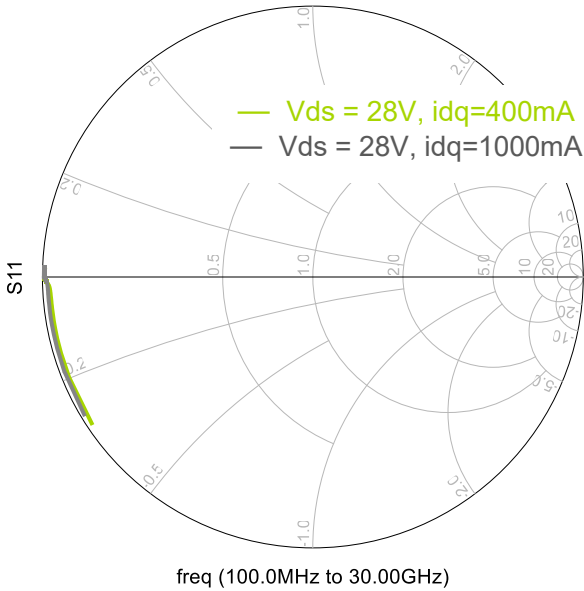
## Thermal and Reliability



### Notes

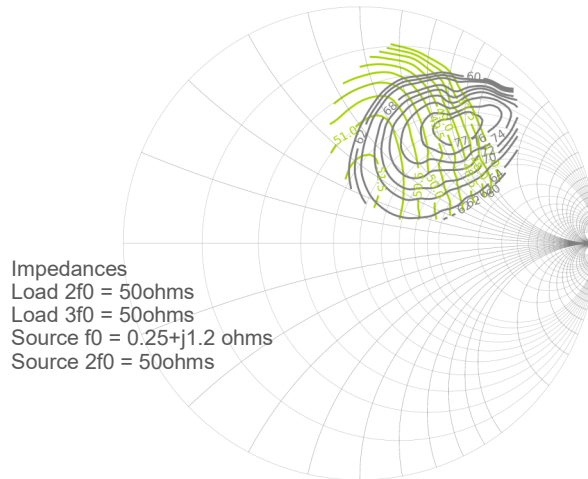
1. Assumes silver sintered epoxy attach (15um thick) and mounted on CuMo carrier
2. Base temperature is assumed at the top of the CuMo carrier

## Model S-parameters | $T_A = 25^\circ\text{C}$



## Model Load Pull Data 3GHz

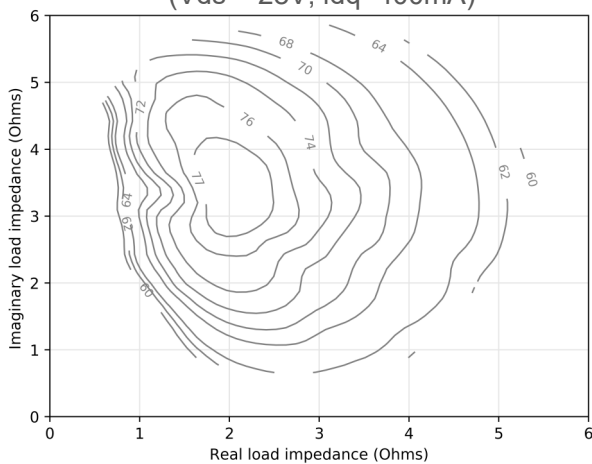
P3dB Output Power and PAE contours  
(Vds = 28V, idq=400mA, Z0=2ohms)



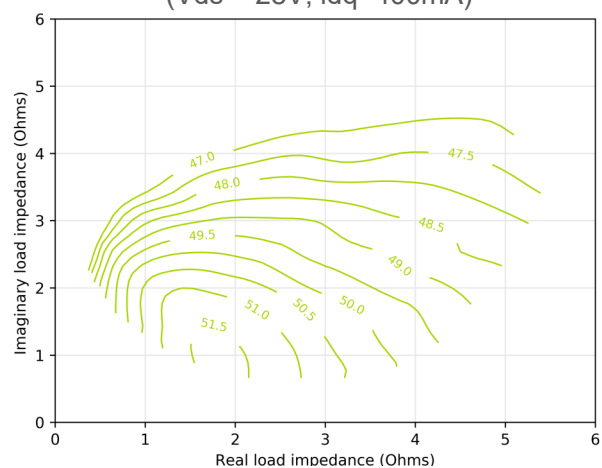
Max PAE = 77.7%  
at Zload = 2.2+j3.2 ohms

Max Power = 51.6dBm  
at Zload = 1.8+j0.9 ohms

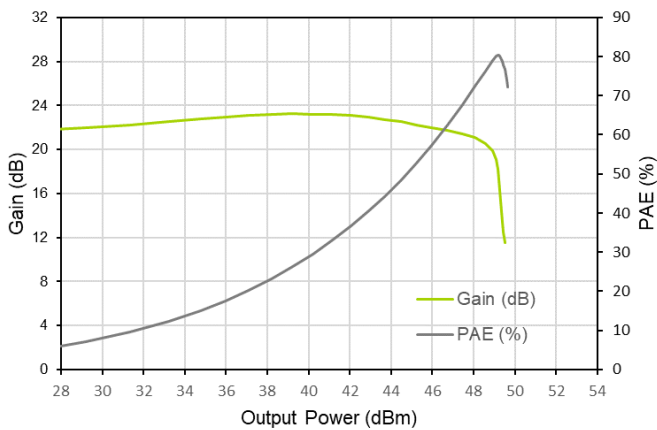
P3dB PAE contours  
(Vds = 28V, idq=400mA)



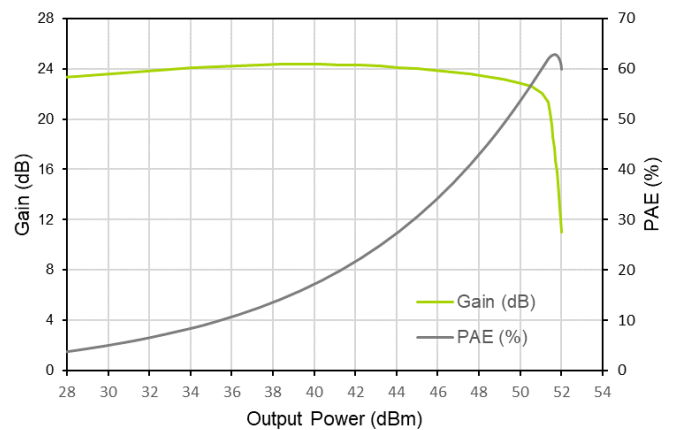
P3dB Output Power contours  
(Vds = 28V, idq=400mA)



Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max PAE tune)

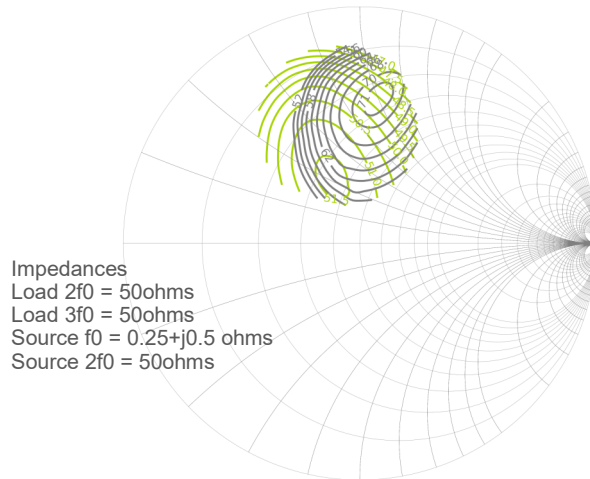


Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max Power tune)



## Model Load Pull Data 6GHz

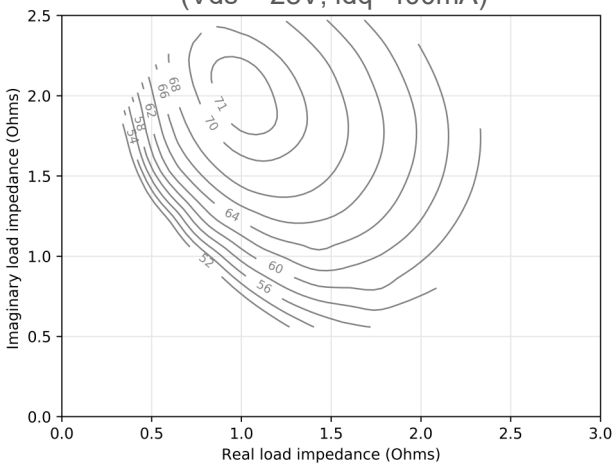
P3dB Output Power and PAE contours  
(Vds = 28V, idq=400mA, Z0=2ohms)



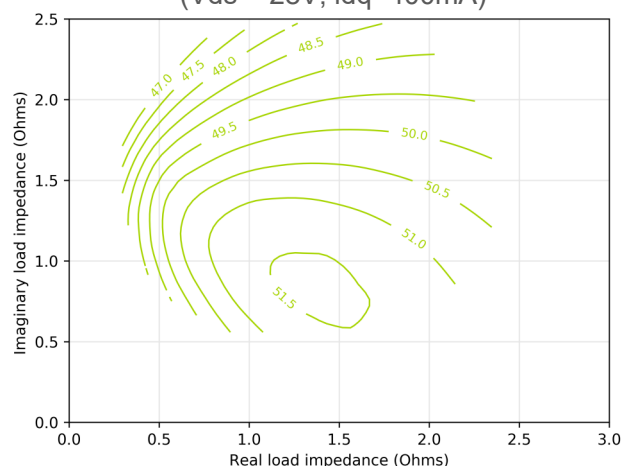
Max PAE = 71.4%  
at Zload = 0.96+j2 ohms

Max Power = 51.6dBm  
at Zload = 1.4+j0.8 ohms

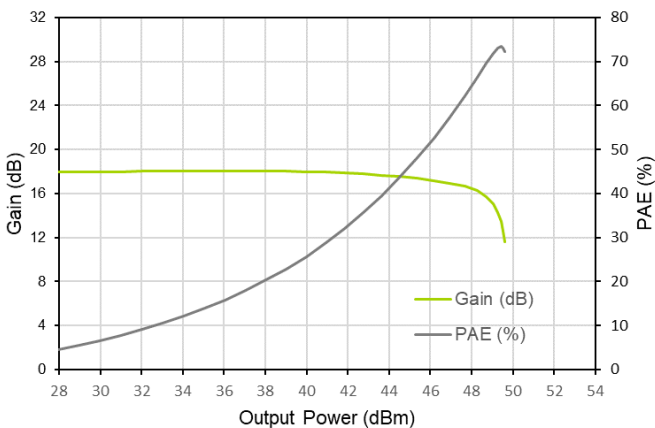
P3dB PAE contours  
(Vds = 28V, idq=400mA)



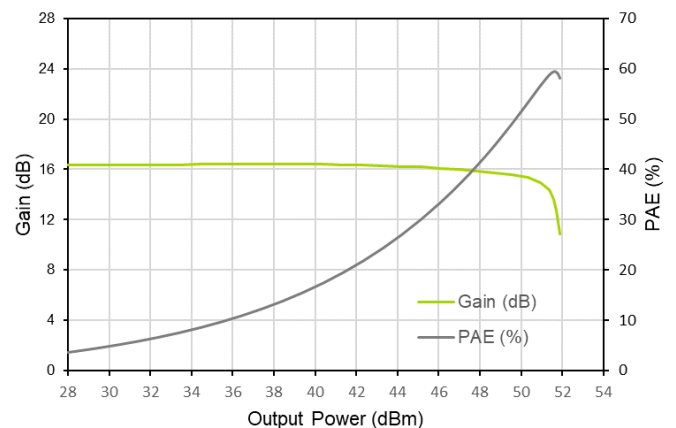
P3dB Output Power contours  
(Vds = 28V, idq=400mA)



Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max PAE tune)

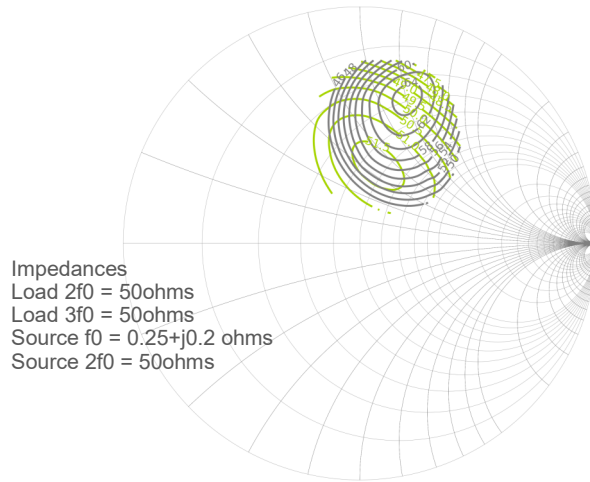


Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max Power tune)



## Model Load Pull Data 10GHz

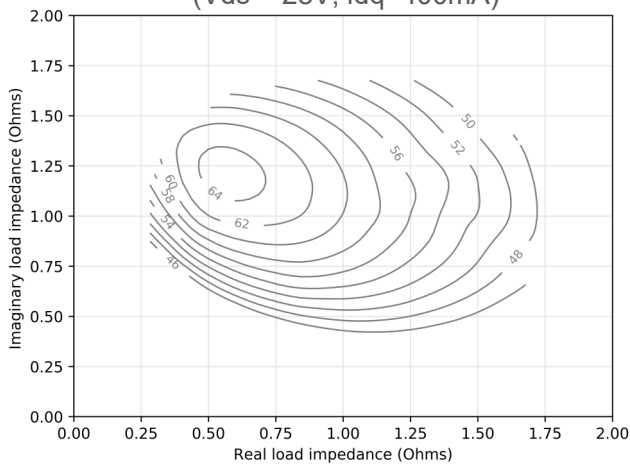
P3dB Output Power and PAE contours  
(Vds = 28V, idq=400mA, Z0=1ohms)



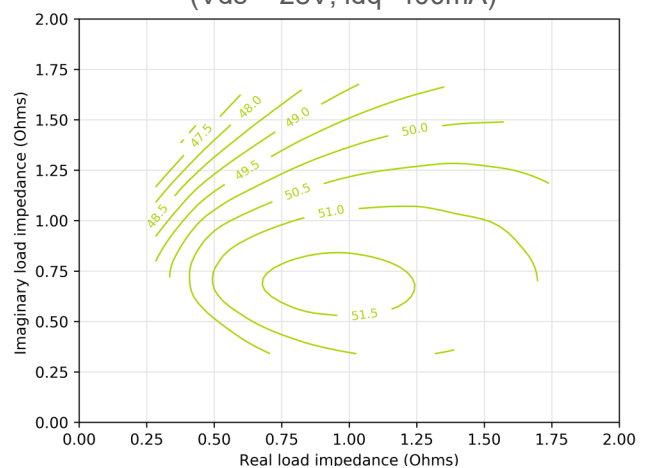
Max PAE = 64.4%  
at Zload = 0.62+j1.15 ohms

Max Power = 51.6dBm  
at Zload = 0.92+j0.66 ohms

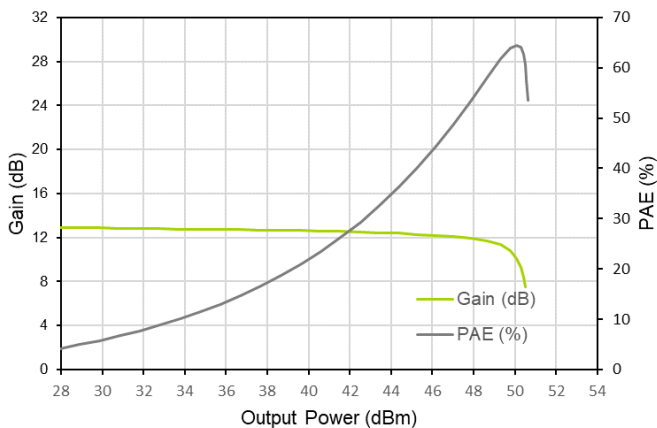
P3dB PAE contours  
(Vds = 28V, idq=400mA)



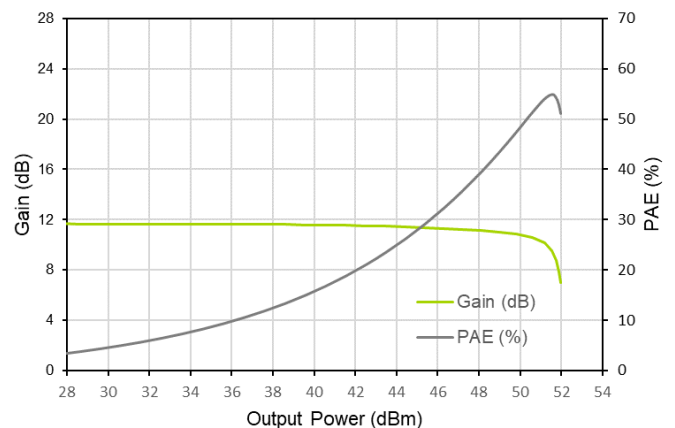
P3dB Output Power contours  
(Vds = 28V, idq=400mA)



Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max PAE tune)

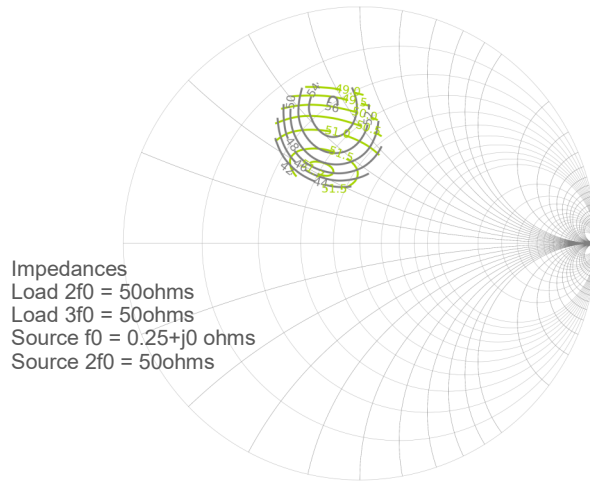


Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max Power tune)



## Model Load Pull Data 14GHz

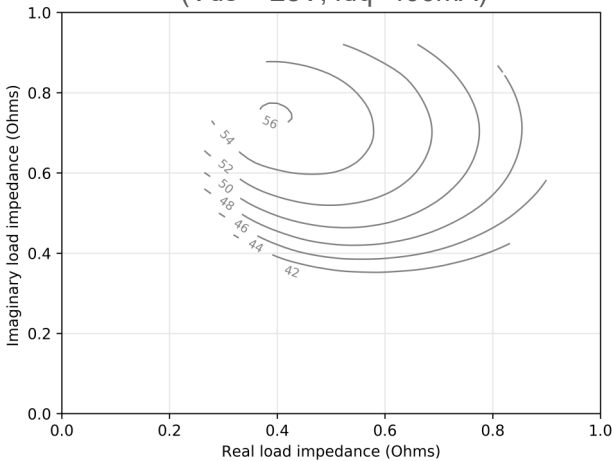
P3dB Output Power and PAE contours  
(Vds = 28V, idq=400mA, Z0=1ohms)



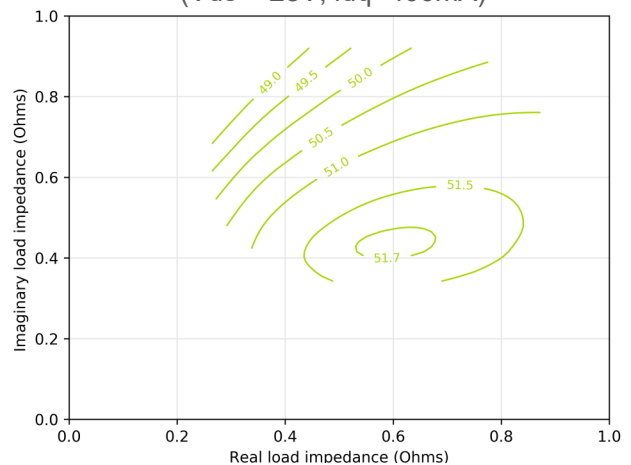
Max PAE = 55.7%  
at Zload = 0.4+j0.75 ohms

Max Power = 51.6dBm  
at Zload = 0.6+j0.44 ohms

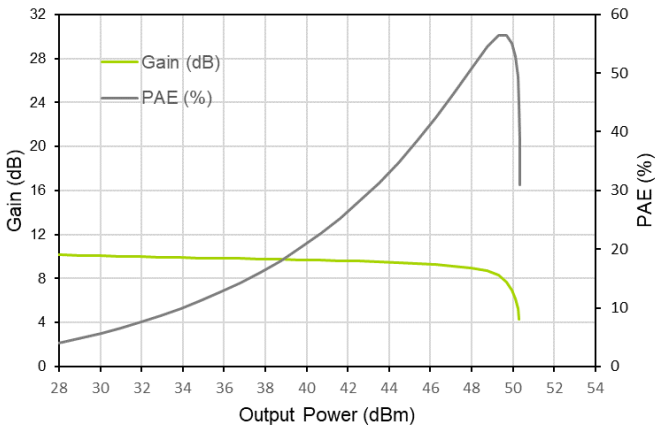
P3dB PAE contours  
(Vds = 28V, idq=400mA)



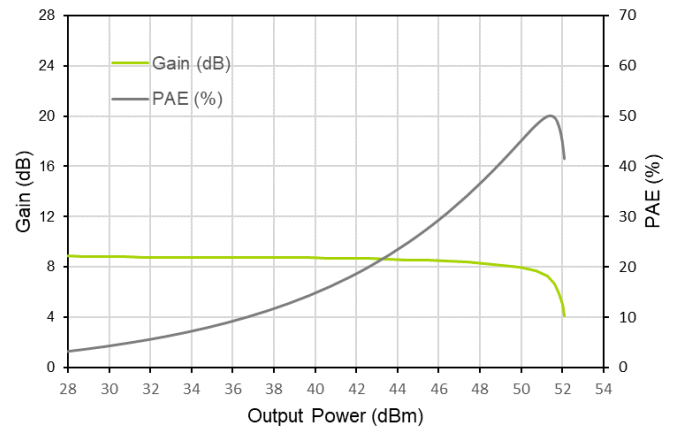
P3dB Output Power contours  
(Vds = 28V, idq=400mA)



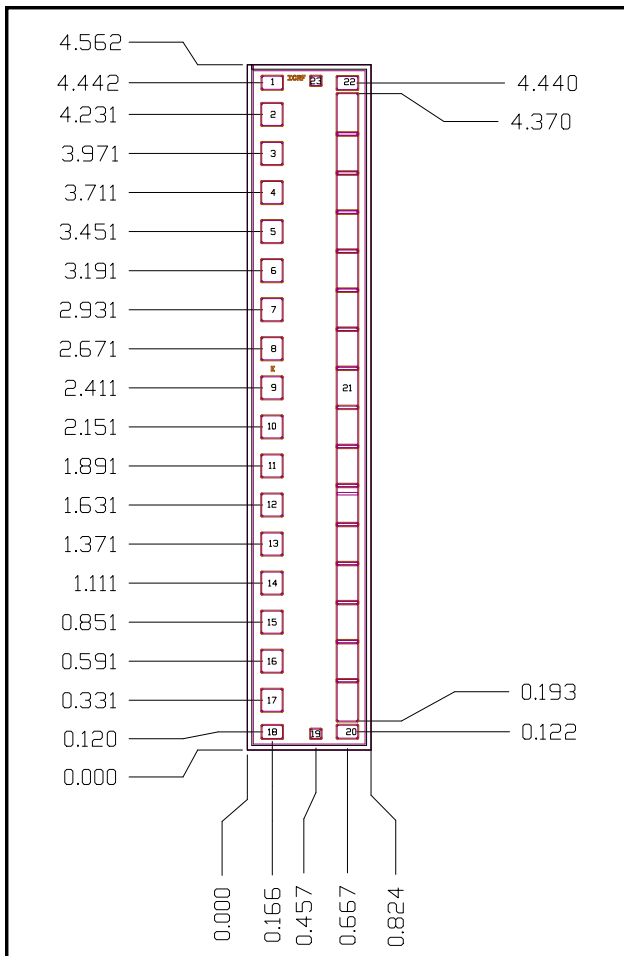
Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max PAE tune)



Gain and PAE vs Output Power  
(Vds=28V, idq=400mA, Max Power tune)



### Mechanical Drawing



### Bond Pads

Pad Number	Description	Dimensions (mm)
1,18	Gate Resistor	0.137 x 0.870
2-17	Gate	0.137 x 0.147
19, 23	Source	0.07 x 0.062
20,22	Drain Resistor	0.137 x 0.087
21	Drain	4.17 x 0.137
Die Backside	Source	4.562 x 0.824

### Bias-Up Procedure

1. Set  $V_G = -5V$
2. Set  $V_D$  to 28V
3. Adjust  $V_G$  positive until  $I_D$  quiescent achieved
4. Limit  $I_D$  to 8A
5. Apply RF Signal

### Bias-down Procedure

1. Turn off RF
2. Turn off  $V_D$ , allow drain capacitor to discharge
3. Turn off  $V_G$ .

### Assembly Guidance

#### Die attach of component using adhesive

- Vacuum collets are preferred method of pickup
- Silver sintered epoxy is recommended -Namics H9890-6A, Kyocera CT2700R7S

#### Die attach of component using Eutectic

- Flux-less gold-tin (AuSn) (80% Au, 20% Sn with a melting point of 280°C) preform is preferred between the die and attached surface.
- Recommended preform should be approximately 0.0012" thick.
- Die bonder using heated collet with a temperature of 310°C and die scrubbing should be used to ensure wetting and prevent formation of voids.
- Exposure to extreme temperature should be kept to a minimum.
- The optimum die attach environment is nitrogen atmosphere.

### Interconnect assembly Notes

- Ball Bonding and wedge bonding is preferred technique
- Force, time and ultrasonic parameters are critical
- Aluminum wire bonding is not recommended
- Bond Wire diameter of 1.5mil is recommended

### Handling Procedures

Please observe the following precautions to avoid damage:

### Static Sensitivity

Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.



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